

Re: RSL10 SIP BLE Module Labelling Request

To Whom It May Concern,

We would like to request the movement of the FCC ID and IC ID into the User's Manual for this product based on the details provided below.

Description of product: Bluetooth 5 System-in-Package Module FCC ID: 2APD9-RSL10SIP IC: 23763-RSL10SIP HVIN: RSL10SIP PMN: NCH-RSL10-101S51-ACG

This product's small size presents a challenge for on-product markings. Total dimensions for the product are 6mm x 8mm x 2mm as pictured in Appendix A, attached. Since marking on the unit is done via metal etching, the available marking area is the silver metal area shown in the photographs in Appendix A is 6mm x 5mm.

Pursuant to FCC § 2.925(f) and § 15.19(a)(5) and ISED RSP-100 §3.1, we would propose moving the product identifiers into the User's Manual and Product Packaging instead of marking the product directly. Thank you in advance for your consideration.

Sincerely,

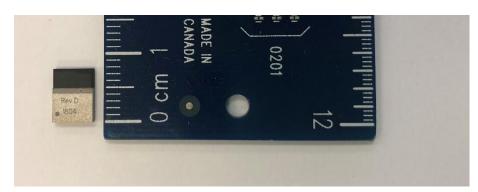
ZairdBarbury

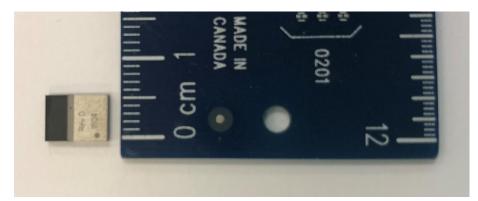
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Date: 2018-08-20

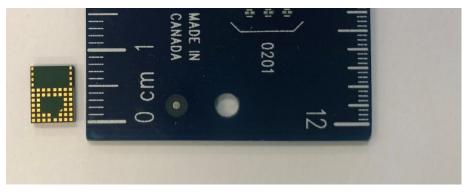


Appendix A: Product Photos *Metric ruler for reference*









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